

## Small Signal Fast Switching Diode



### FEATURES

- Silicon epitaxial planar diode
- Electrical data identical with the device 1N4151
- MicroMELF package
- Material categorization:  
for definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



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**FREE**

### APPLICATIONS

- Extreme fast switches

### LINKS TO ADDITIONAL RESOURCES



### MECHANICAL DATA

**Case:** MicroMELF

**Weight:** approx. 12 mg

**Cathode band color:** black

**Packaging codes / options:**

TR3/10K per 13" reel (8 mm tape), 10K/box

TR/2.5K per 7" reel(8 mm tape), 12.5K/box

### PARTS TABLE

| PART    | TYPE DIFFERENTIATION    | ORDERING CODE             | CIRCUIT CONFIGURATION | REMARKS       |
|---------|-------------------------|---------------------------|-----------------------|---------------|
| MCL4151 | $V_{RRM} = 75\text{ V}$ | MCL4151-TR3 or MCL4151-TR | Single                | Tape and reel |

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

| PARAMETER                       | TEST CONDITION               | SYMBOL      | VALUE | UNIT |
|---------------------------------|------------------------------|-------------|-------|------|
| Repetitive peak reverse voltage |                              | $V_{RRM}$   | 75    | V    |
| Reverse voltage                 |                              | $V_R$       | 50    | V    |
| Peak forward surge current      | $t_p = 1\text{ }\mu\text{s}$ | $I_{FSM}$   | 2     | A    |
| Repetitive peak forward current |                              | $I_{FRM}$   | 450   | mA   |
| Forward continuous current      |                              | $I_F$       | 200   | mA   |
| Average forward current         | $V_R = 0$                    | $I_{F(AV)}$ | 150   | mA   |
| Power dissipation               |                              | $P_{tot}$   | 500   | mW   |

### THERMAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

| PARAMETER                                  | TEST CONDITION                                                                                                        | SYMBOL     | VALUE       | UNIT               |
|--------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|------------|-------------|--------------------|
| Thermal resistance junction to ambient air | Mounted on epoxy-glass hard tissue, fig. 4, 35 $\mu\text{m}$ copper clad, 0.9 $\text{mm}^2$ copper area per electrode | $R_{thJA}$ | 500         | K/W                |
| Junction temperature                       |                                                                                                                       | $T_j$      | 175         | $^{\circ}\text{C}$ |
| Storage temperature range                  |                                                                                                                       | $T_{stg}$  | -65 to +175 | $^{\circ}\text{C}$ |

| <b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |                                                                                            |            |      |       |      |               |
|----------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|------------|------|-------|------|---------------|
| PARAMETER                                                                                                | TEST CONDITION                                                                             | SYMBOL     | MIN. | TYP.  | MAX. | UNIT          |
| Forward voltage                                                                                          | $I_F = 50\text{ mA}$                                                                       | $V_F$      |      | 0.880 | 1    | V             |
| Reverse current                                                                                          | $V_R = 50\text{ V}$                                                                        | $I_R$      |      |       | 50   | nA            |
|                                                                                                          | $V_R = 50\text{ V}, T_J = 150\text{ }^{\circ}\text{C}$                                     | $I_R$      |      |       | 50   | $\mu\text{A}$ |
| Breakdown voltage                                                                                        | $I_R = 5\text{ }\mu\text{A}, t_p/T = 0.01,$<br>$t_p = 0.3\text{ ms}$                       | $V_{(BR)}$ | 75   |       |      | V             |
| Diode capacitance                                                                                        | $V_R = 0\text{ V}, f = 1\text{ MHz},$<br>$V_{HF} = 50\text{ mV}$                           | $C_D$      |      |       | 2    | pF            |
| Reverse recovery time                                                                                    | $I_F = I_R = 10\text{ mA},$<br>$i_R = 1\text{ mA}$                                         | $t_{rr}$   |      |       | 4    | ns            |
|                                                                                                          | $I_F = 10\text{ mA}, V_R = 6\text{ V},$<br>$i_R = 0.1 \times I_R, R_L = 100\text{ }\Omega$ |            |      |       | 2    |               |

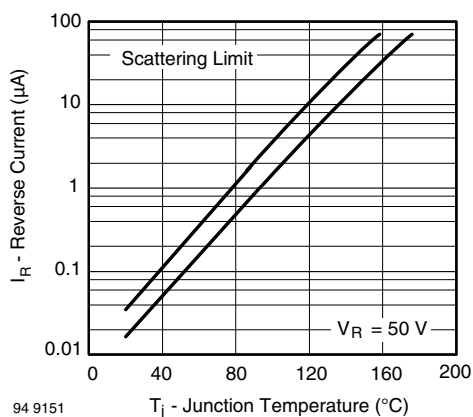
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Reverse Current vs. Junction Temperature

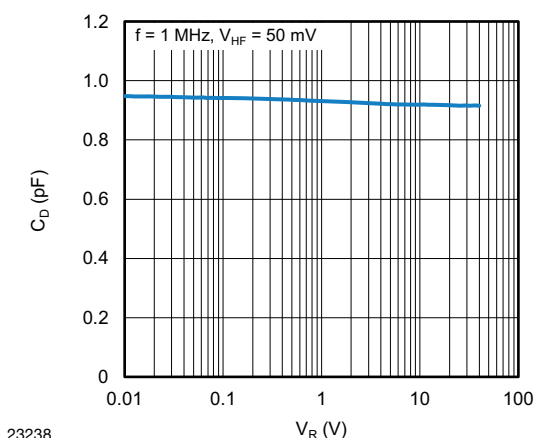


Fig. 3 - Typical Capacitance vs. Reverse Voltage

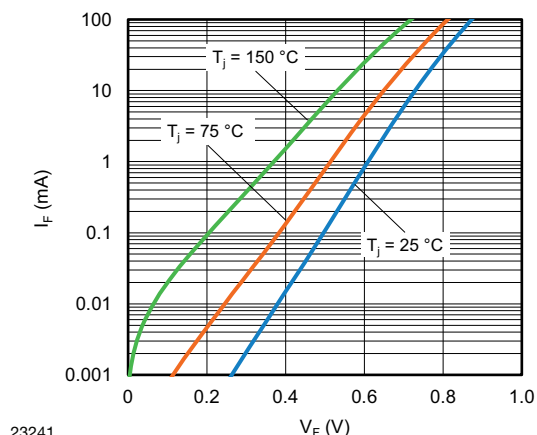
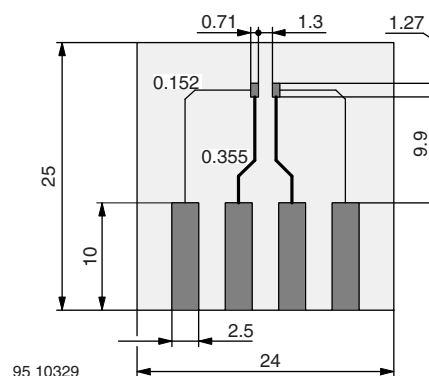
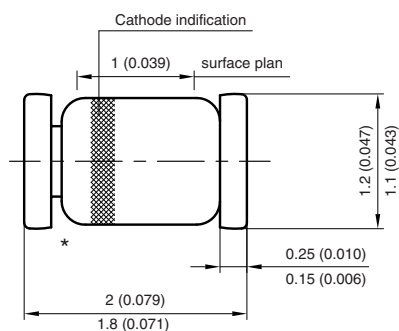


Fig. 2 - Forward Current vs. Forward Voltage

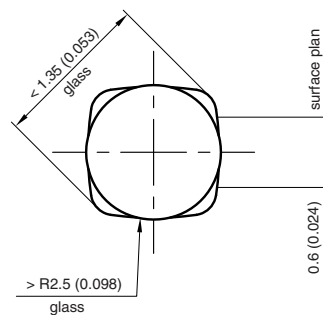

Fig. 4 - Board for  $R_{\theta JA}$  Definition (in mm)



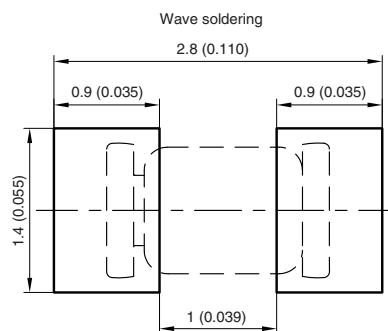
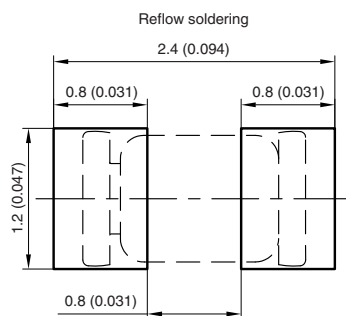
**PACKAGE DIMENSIONS** in millimeters (inches): **MicroMELF**



\* The gap between plug and glass can be either on cathode or anode side



Foot print recommendation:



Created - Date: 26.July.1996  
Rev. 13 - Date: 07.June.2006  
Document no.:6.560-5007.01-4  
96 12072



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